



MEL98-002CCC-CIPB

February 26, 2004

To: Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Fr: Stephen B. Ackerman, Reg. No. 37,761  
28 Davis Avenue  
Poughkeepsie, N.Y. 12603

Subject:

Serial No. 10/783,195

2/20/04

MOU-SHIUNG LIN

"TOP LAYERS OF METAL FOR HIGH  
PERFORMANCE IC'S"

#### PRELIMINARY AMENDMENT

Dear Sir:

Please enter the following Preliminary Amendment for the above-identified application  
for patent:

#### CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal  
Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box  
1450, Alexandria, VA 22313-1450, on March 25, 2004.

Stephen B. Ackerman, Reg. No. 37,761

Signature

Date March 25, 2004

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Amendments to the Specification begin on page 3 of this paper.

Remarks/Arguments begin on page 4 of this paper.